



Corezzle accelerates innovation by producing
Generative Hardware with **SiP** technology.

Innovation Accelerated

Emin YÜCEL

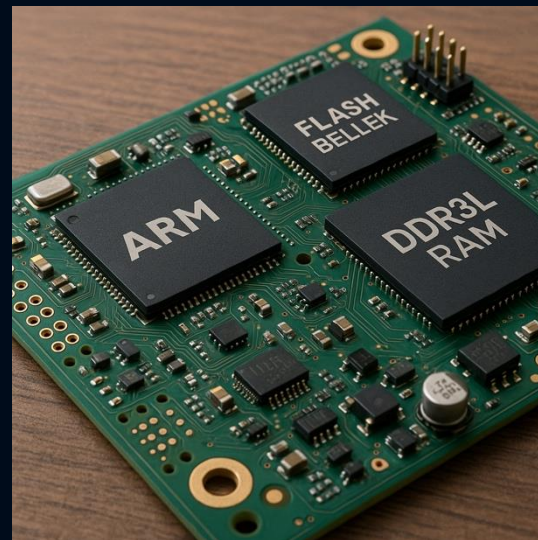
Problem



PCB production is still slow, costly, and complex — keeping hardware innovation from matching the pace of software.



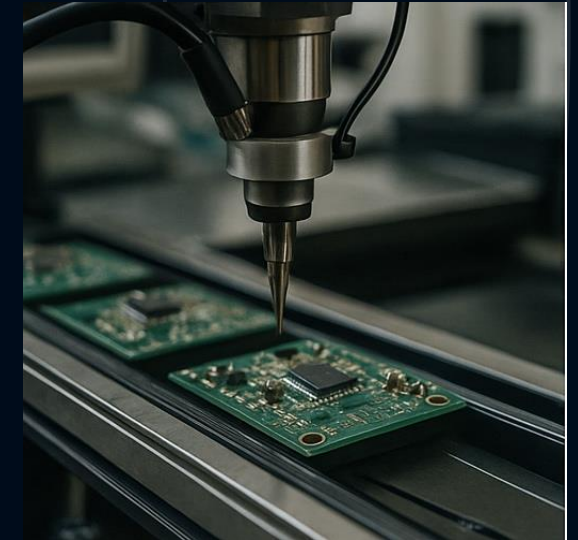
Engineering Cost
\$10K - \$20K



Complex Circuit Design
2 - 3 months

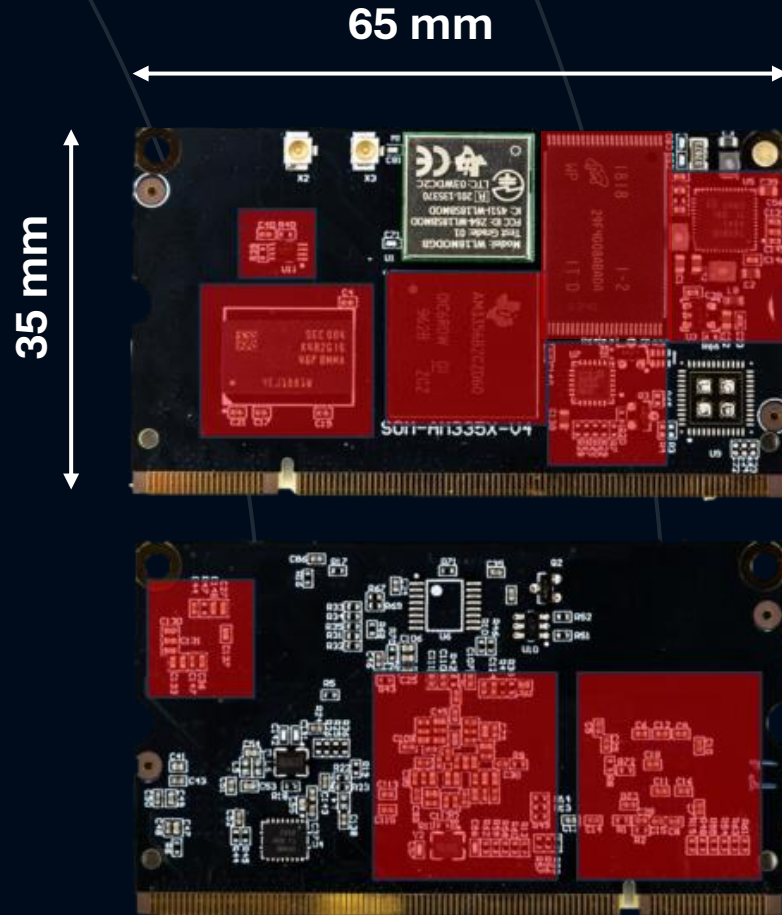


Supply Chain
35 different components



Mass Production
Assembly Cost
173 Components

Solution



Up to 61%
Reduction



Single component



Solution



Game-Changing Corezzle Approach

Corezzle delivers groundbreaking solutions in Generative AI Hardware for designers and developers.



Single-die
Packaging



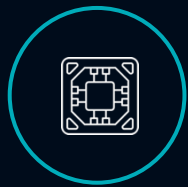
Packaging Engineering
Expertise



Multi-die
Packaging



Testing &
Validation



SiP
Packaging



Production-ready
SiP Modules

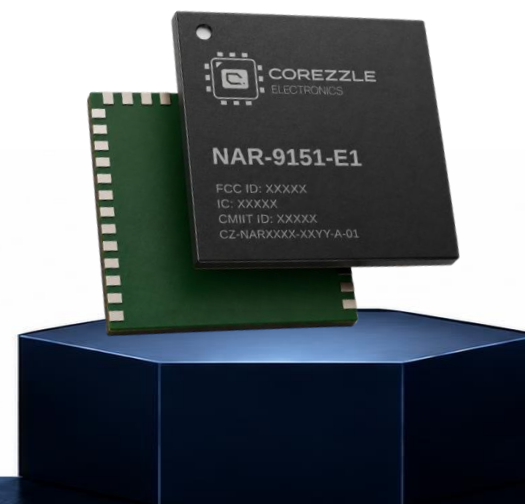
Product Range



Industrial



IoT & Wearable



Cellular IoT



EDGE AI



Corezza
At The Heart of
All Systems.

Market Analysis

By the end of 2032, Corezzle aims to capture a 0.3% share of Turkey's electronic components sales and distribution market and generate \$18 million in revenue.

IBISWorld **SKYQUEST** statista 

TAM
\$14B
billion

SAM
\$6
billion

SOM
\$59
million

Competitor Analysis

	SiP	Power Management	Specific Operating System	Generative AI	Open-Source Software	Target Domains
Corezzle	+++	+++	+++	+++	+++	SiP - AI
Nordic	+++	++	-	+	-	SiP-SoC
Octavo	+++	+++	+	++	++	SiP
Murata	+++	++	-	-	-	SiP-RF-IoT

Business Model



WHO

4 SEGMENTS

Industrial

IoT & Wearable

Cellular IoT

Edge AI

HOW

B2B → PILOT → SCALE

Launch · Custom Pack · Scale

2026 → 2027 → 2028+

WHAT EARNS

UNIT SALES

+

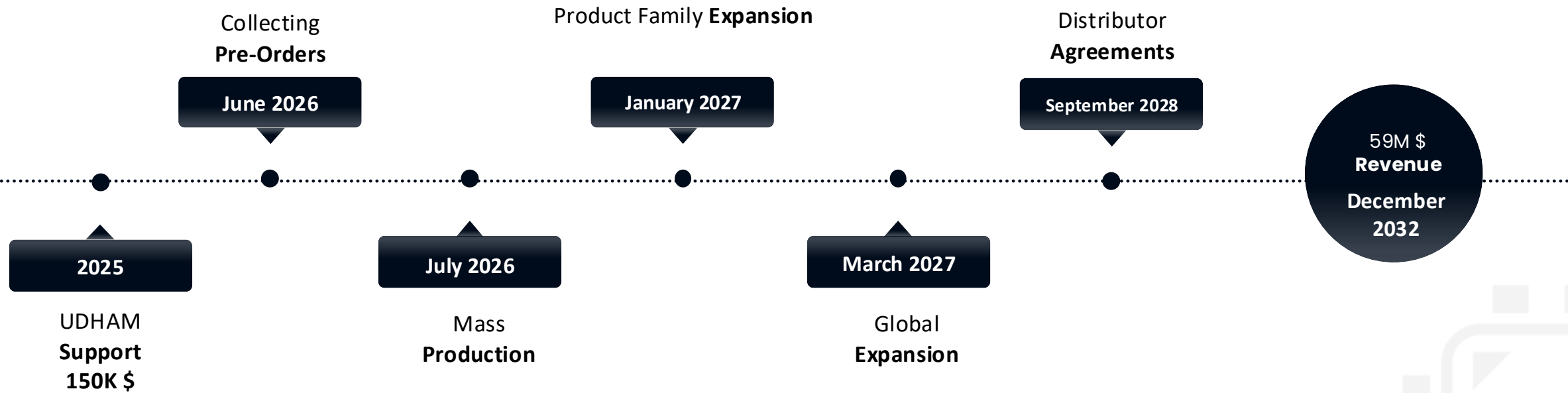
CUSTOM PACK

(2028+)

Direct B2B, 4 SiP × 4 segment, reference pilots ile büyür, 2028+ custom packaging ile ölçeklenir.

Road Map

Corezzle's roadmap focuses on scaling production-ready System-in-Package (SiP) AI modules that cut hardware prototyping cycles from months to days.



Meet The Team



Emin Yücel
Co-founder-CEO & SiP Package Designer



Faddale Demir
Co-founder-CTO & SiP Package Designer



Ahmet Kerim Nalbant
Executive Board Member



Abdurrahman Joulha
Europe BD & Marketing Manager



Hilal Nur Yücel
Software Developer



Halil Demir
Software Developer



Furkan Dikmen
Packaging Process Engineer



Fatmanur Çakır
Hardware Designer

Revenue Model



The Generative Hardware portfolio targets 4 different segments and offers solutions tailored to the varying needs of each company by keeping the ASP range broad.

Thank You Innovation Accelerated



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